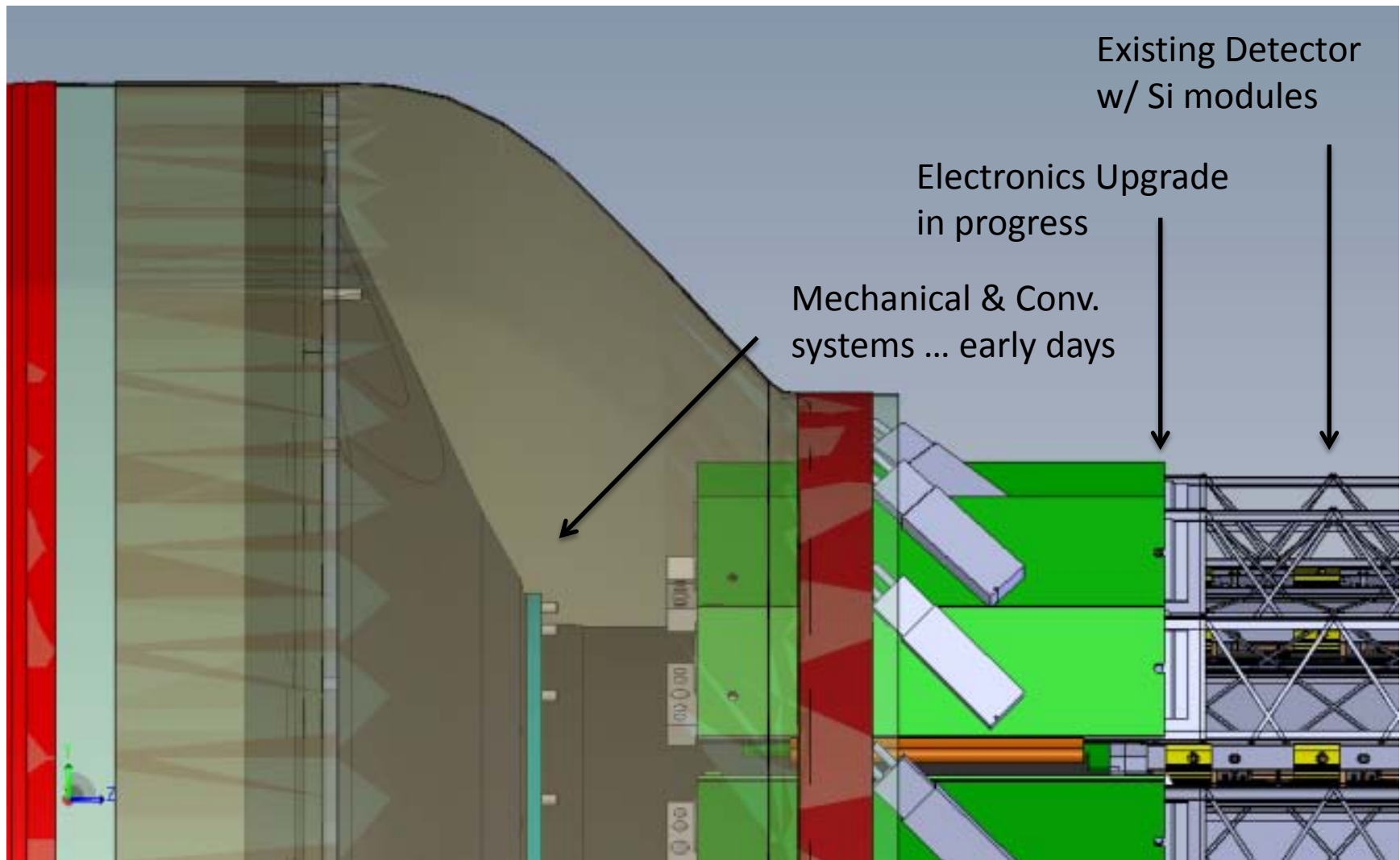


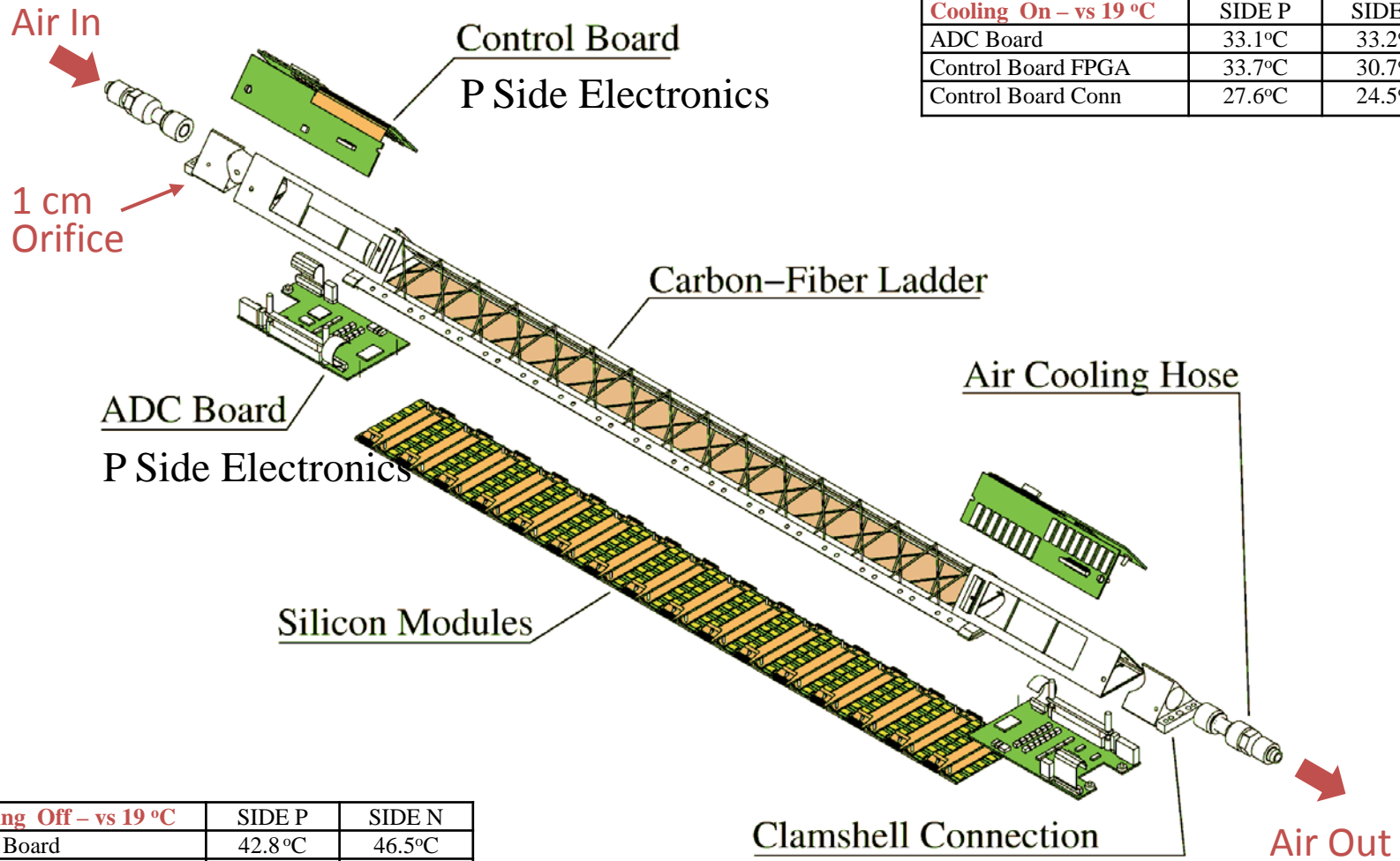
# Conventional Systems: Cooling, Power Supplies, Cables, and ~~all~~ some of that stuff

Jim Thomas  
Lawrence Berkeley National Laboratory

# To Do: Final routing of cooling & cables



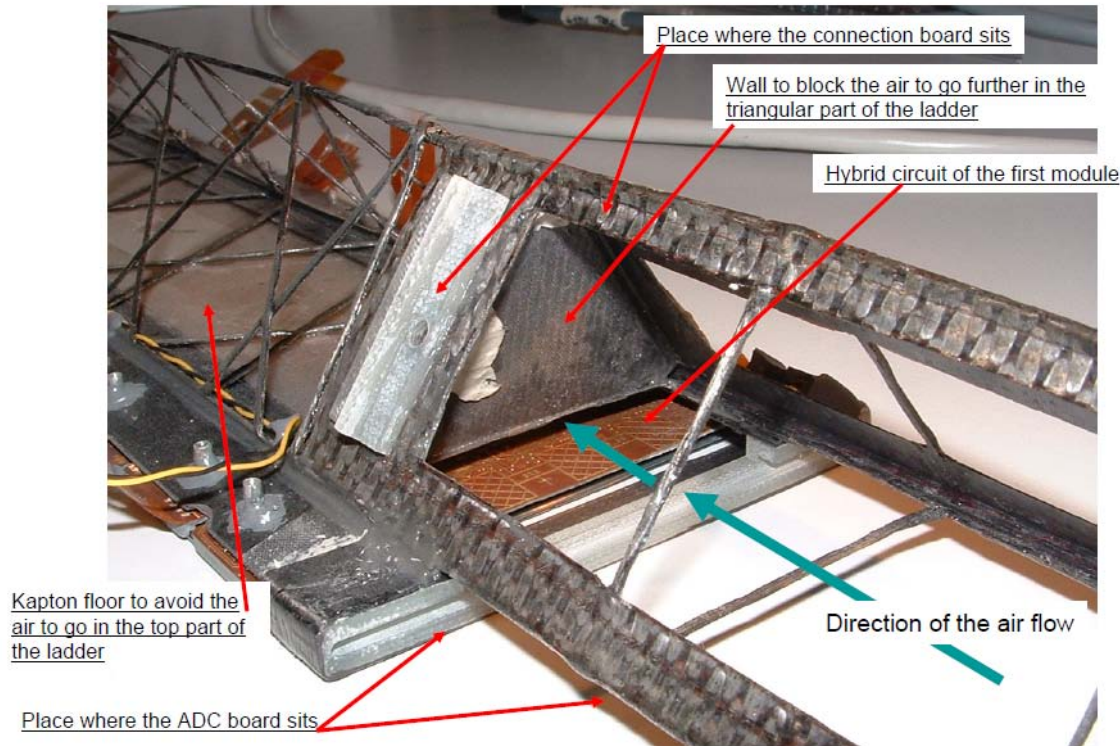
# The SSD is air cooled – (2002 test results)



Cooling On – vs 19 °C	SIDE P	SIDE N
ADC Board	33.1°C	33.2°C
Control Board FPGA	33.7°C	30.7°C
Control Board Conn	27.6°C	24.5°C

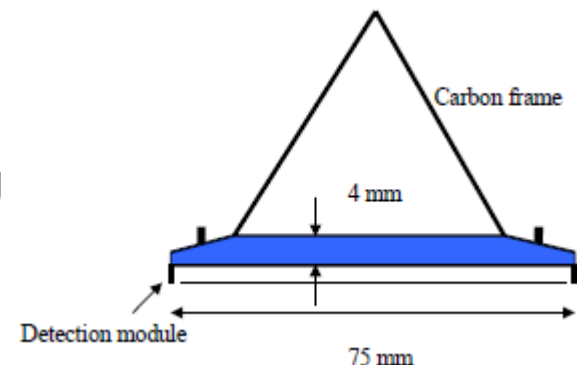
Cooling Off – vs 19 °C	SIDE P	SIDE N
ADC Board	42.8°C	46.5°C
Control Board FPGA	34.8°C	36.5°C
Control Board Conn	45.2°C	45.4°C

# Air Path in an SSD Ladder

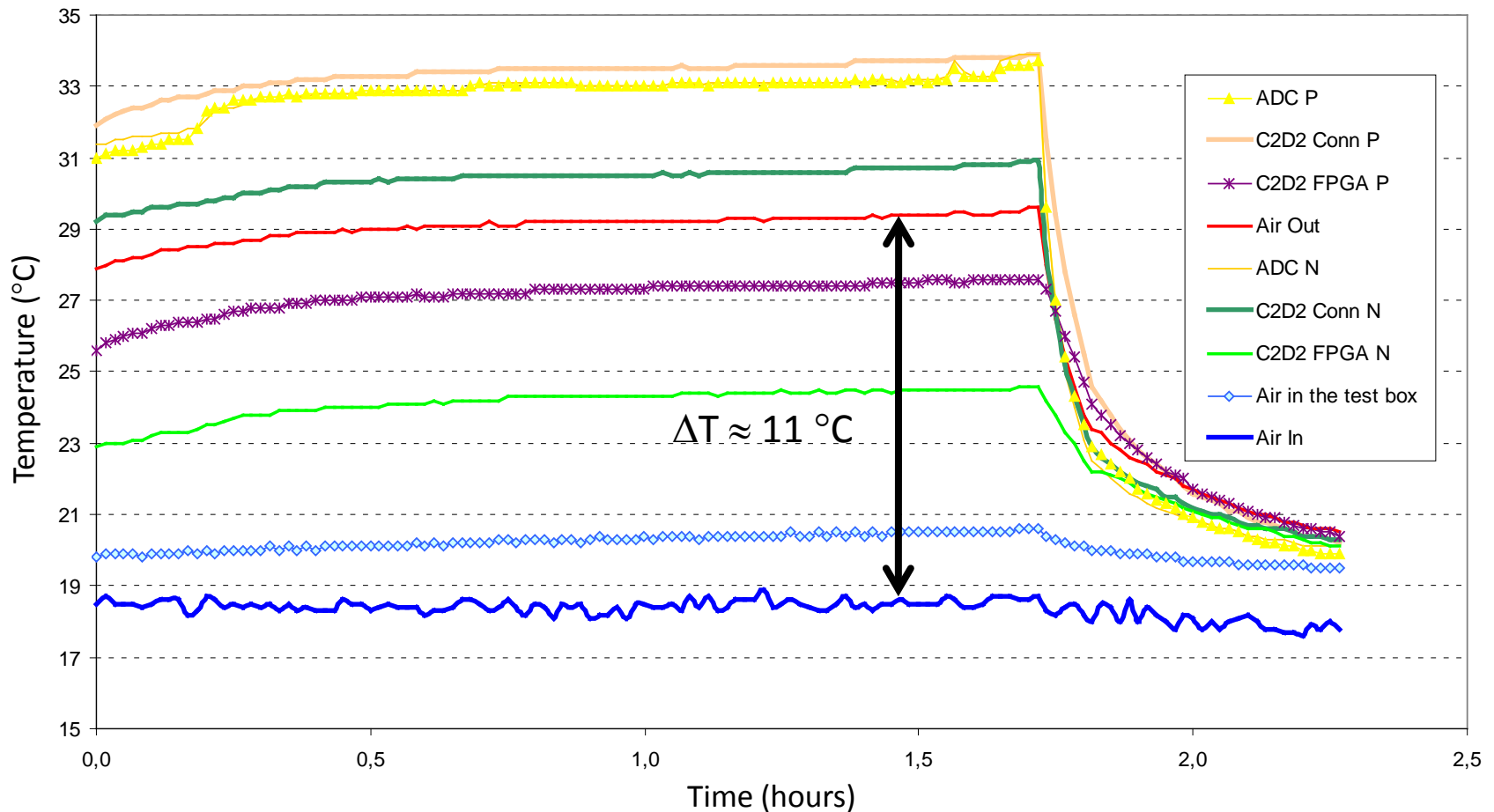


- Air at the midline of the detector travels through a tunnel, 75 mm x 4 mm (or  $\sim 3 \text{ cm}^2$ )
- Length of this air tunnel is  $\sim 68 \text{ cm}$  (not including ladder board sections on ends)
- An air flow of 1 liter/sec through the tunnel corresponds to an air speed of 3.3 m/sec

- Air enters the ladder board region through an  $\sim 1 \text{ cm}$  orifice
- The entire ladder is wrapped in mylar to trap the air flow inside the triangular structure of the ladder
- The air flow is blocked by a 'wall' to force the air over the Si detectors



# Performance of Cooling System on Ladder #0



Measurements confirm that the majority of heat from the ladder is transferred to the cooling air stream. The system is efficient.

# New Electronics – New Expectations



<b>FEE POWER</b>	Number of elements	Predicted Power	Measured Power
Detection Module w/ parallel readout	16 per ladder	720 mW per module	
<b>TOTAL FEE</b>		<b>11.5 W</b>	

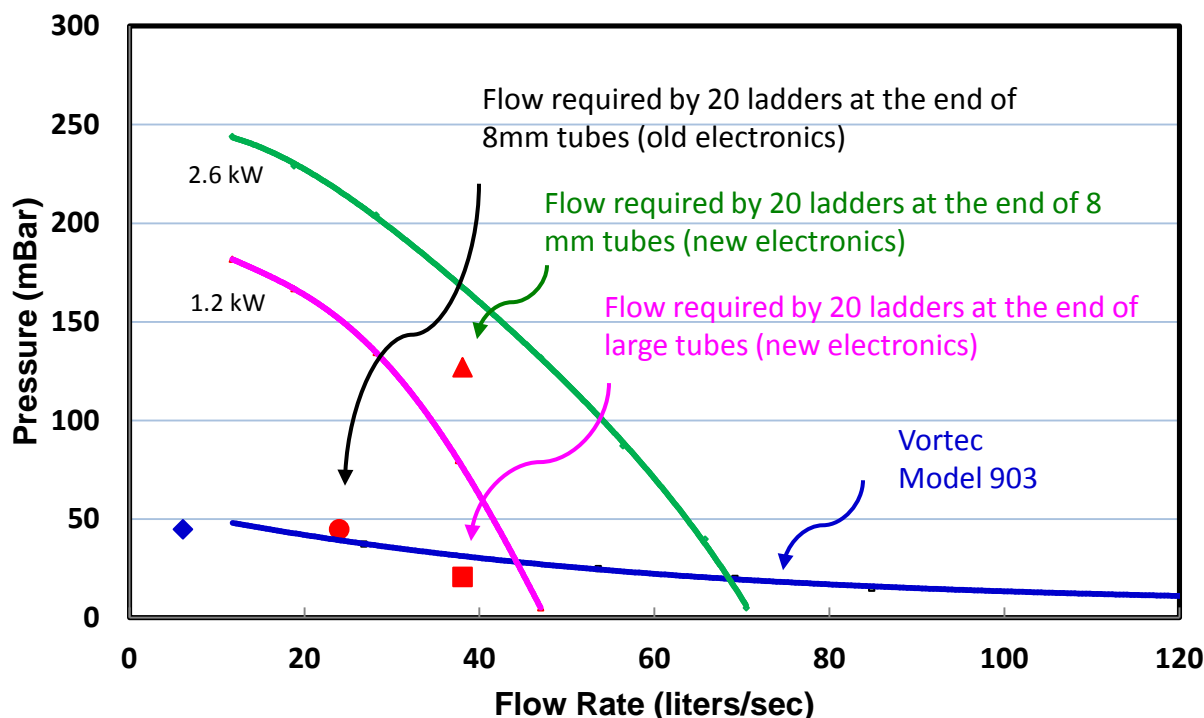
<b>New Electronics Boards</b>	Number of elements	Predicted Power	Measured Power
Ladder Boards	2 per Ladder	6.7 W per card	
<b>Total Electronic Boards/Ladder</b>		<b>13.4 W</b>	

Total Consumption: 25 Watts per Ladder  
24 watts typical / 26 watts max

- 25 Joules into 1 liter of air suggests a  $\Delta T$  of  $\sim 21$  degrees  $^{\circ}K$  at the old flow rate of 1 liter/sec (ambient air is  $24^{\circ}$  so total is  $45^{\circ}$ , which is in the danger zone).
  - Heat capacity of lab air is  $0.0012 \text{ J} / \text{cm}^3 / ^{\circ}K$
- So to achieve the same  $\Delta T$  as before, we need 1.6 liters/second of air flow with a velocity of 0.8 m/sec near the ladder boards and 5.4 m/sec over the Si detectors

We need more air than before, also careful about vibrations

# Dust Collector Vacuum Sources



'Large tubes' means 4 long tubes with 2.5 cm (ID) each, then distributed locally to 20 ladders without additional pressure drop

- A wide variety of options are available. Shown above are the vacuum curves for a 1.2 kW and a 2.6 kW vacuum system from a company in California. (Old system was 76 kW)

The airflow can be increased ~2x by using a bigger pump and larger tubes

# More Air ... is available



- The wood products industry uses high volume vacuum sources to clear wood chips from around saws and lathes.
- Thus, there is a commercial line of vacuum sources that provide vacuum with more flow and pressure than we need.
- These vacuum sources can be purchased, off the shelf, and are designed for continuous operation. They run on 3 phase 240 VAC.
- We have tested the 1.2 kW model. Depending on losses, may need 2.6 kW model

<http://www.dustcollectorsource.com>



# Power Requirements for the SSD



	-2 V	+2 V	+5 V
typical	870 mA	2172 mA	909 mA
max	883 mA	2186 mA	1357 mA

Current for one ladder end (each Nicomat Connector) from "star\_ssdU\_v14" (C. Renard)

	Bias
typical	16*5 $\mu$ A
max	16*10 $\mu$ A

Bias current for one ladder (both ends, due to HV jumper)

## SSD Cable Design Calculator (G. Visser)

INSUL\_T= 0.014 inch

LENGTH= 10 feet

Inner cable

INSUL\_T= 0.011 inch

LENGTH= 85 feet

Outer cable

Service	Vload	Iload	strand	nStrands	cond, in2	total, in2	R	IR	I2R	strand	nStrands	cond, in2	insul, in2	R	IR	I2R	Vsource
+2	2.5	2.2	28CCA	7	0.000873	0.002955	0.144286	0.317429	0.698343	26CU	7	0.00139	0.003224	0.497857	1.095286	2.409629	5.325429
-2	2.2	0.9	28CCA	7	0.000873	0.002955	0.144286	0.129857	0.116871	26CU	7	0.00139	0.003224	0.497857	0.448071	0.403264	3.355857
+5	5	1.4	28CCA	7	0.000873	0.002955	0.144286	0.202	0.2828	26CU	7	0.00139	0.003224	0.497857	0.697	0.9758	6.798
BIAS	200	0	28CCA	1	0.000125	0.001295	1.01	0	0	32CU	7	0.000352	0.001463	1.967143	0	0	200
+2 sense	2	0	28CCA	1	0.000125	0.001295	1.01	0	0	32CU	7	0.000352	0.001463	1.967143	0	0	2
-2 sense	2	0	28CCA	1	0.000125	0.001295	1.01	0	0	32CU	7	0.000352	0.001463	1.967143	0	0	2
+5 sense	5	0	28CCA	1	0.000125	0.001295	1.01	0	0	32CU	7	0.000352	0.001463	1.967143	0	0	5

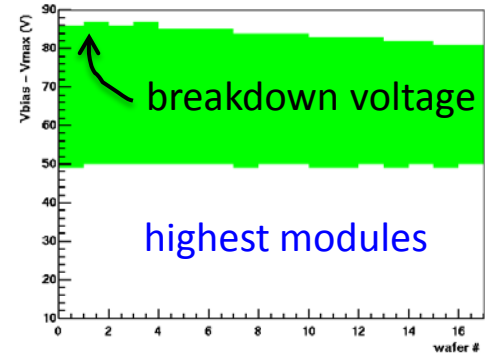
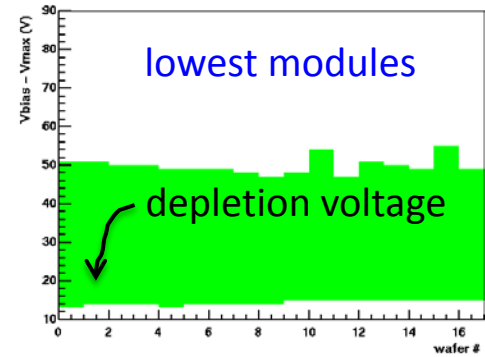
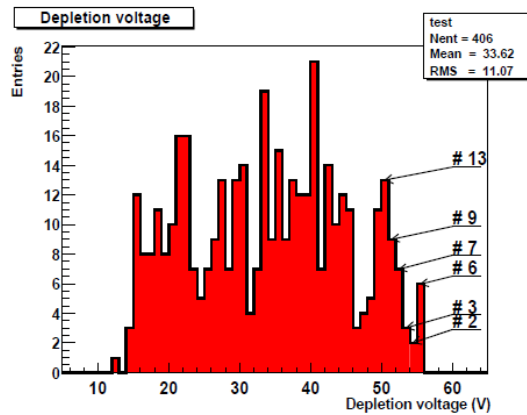
DIA= 0.167588

POWER= 2.196029

DIA= 0.17621

POWER= 7.577386

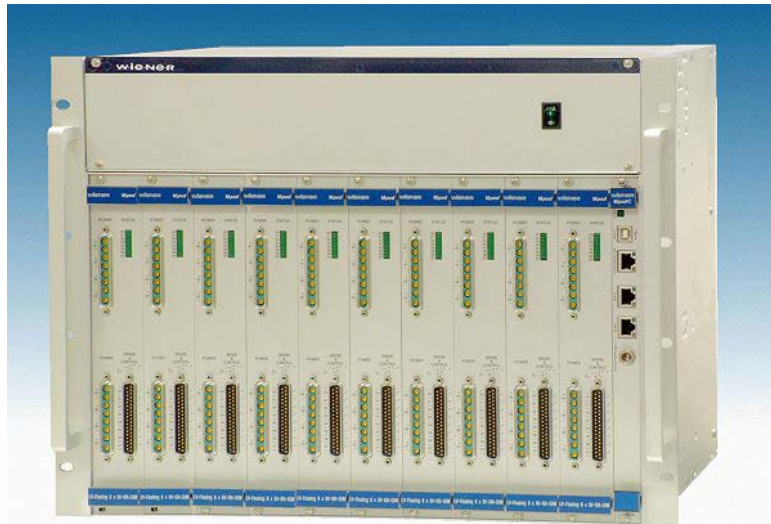
# Bias Voltage settings for the SSD



name	depletion voltage (V)	breakdown voltage (V)
star_015	19	49
star_026	26	61
star_093	20	57
star_050	22	60
star_096	22	56
star_097	21	39
star_103	14	48
star_106	14	46
star_111	18	52
star_115	32	61
star_132	26	58
star_237	25	56
star_280	15	47
star_107		
star_108		
star_046	22	60

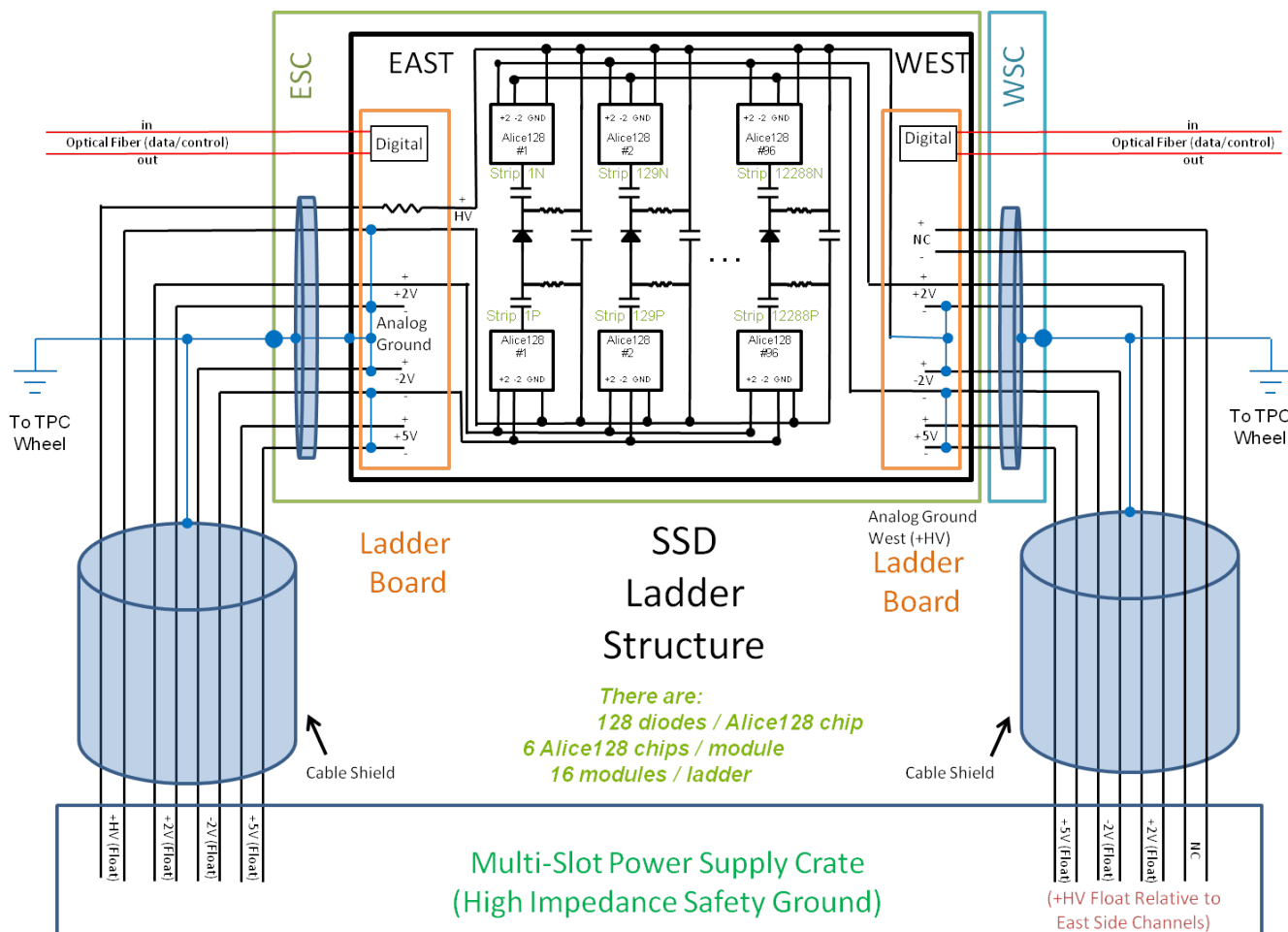
- The modules were sorted and grouped by operating point to form full ladders (16)
- The lowest depletion voltage (out of 406 modules) is 13 V
- The highest breakdown voltage is 86 V
- Thus need a Bias supply with a range from 0-100 V
- Low current, high stability

# Power Supplies



- Upgrade from previous Caen supplies to achieve greater reliability and better interfaces
- Wiener selected for compatibility with FGT, IST, and MTD
- We will use rear facing MPOD crates with facilities for vertical cooling and fans (8U+1U)
- Choices for LV supplies are
  - MPV8008LI 0-8V 5 amp \*
  - MPV8016 0-16V 5 amp
- Choice for Bias supply is
  - Wiener/ISEG EHS F2 01-F High Precision HV Module 16 channel, w/floating ground

# Grounding Plan



- Digital signals over optic fiber
- Si Modules biased to ~50 V
- Single point ground on East
- Analog data read from both sides of pn junction.
  - $p \Rightarrow E, n \Rightarrow W$
- Analog on one end held at HV bias potential
- Power supplies for +2, -2 and +5 are floating PS

# Connectors

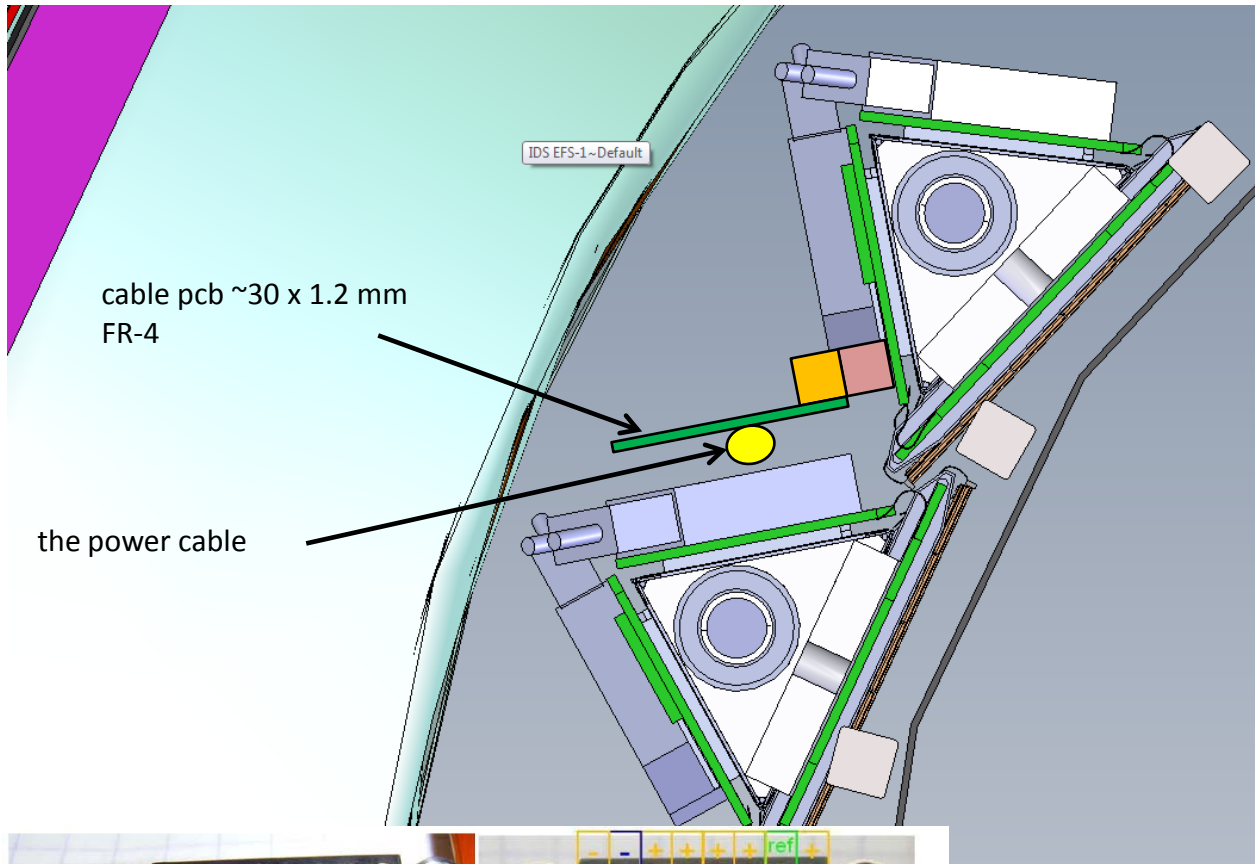
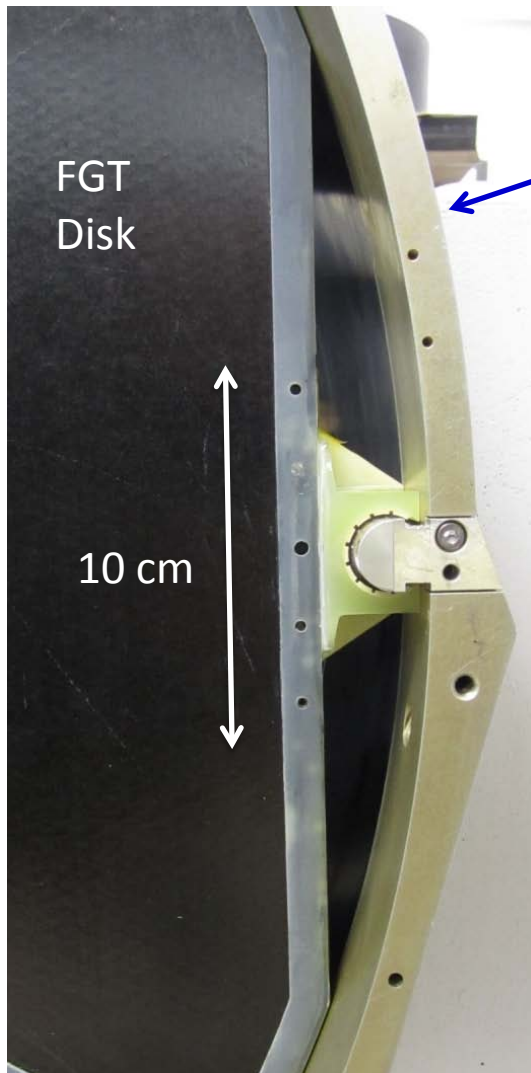


Figure 17: Nicomatic power connector cabling

Nicomat Connectors and auxiliary card  
 Note that Bias supplied to one ladder end, only, due to jumper across ladder

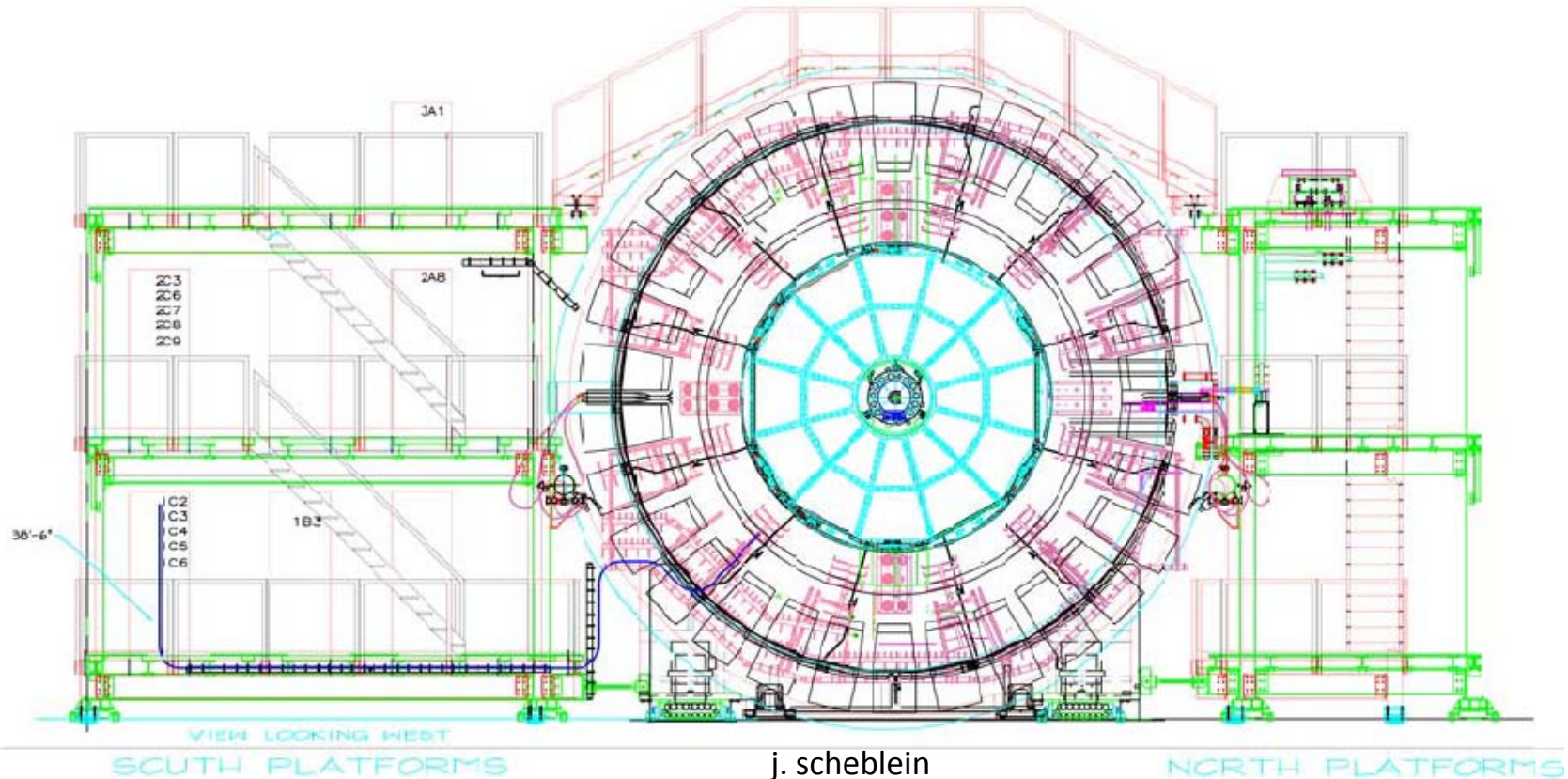
# Cable Trays



West Support Cylinder

- Cable tray needed above and below the FGT rail to hold 5 cables and 5 fiber pairs (5 ladders per tray, 10 ladders left, 10 ladders right, 20 total)
- Cable tray mounted to WSC
- Can only be installed after the FGT has been removed from STAR ... part of summer 13 installation activities
- Not designed yet

# SSD Cable pathways on the platform



- Cable path from Rack 1C6 to PXL patch panel is 70 feet via shortest route
- This summer, we must verify that there is space in these racks (and reserve!)
- Next most desirable path is longer ... on the order of 100 feet

# The Shroud



To Do:

Split the shroud so it is easier to install the SSD ladders

Air in and out for SSD vacuum

Ladder mounts

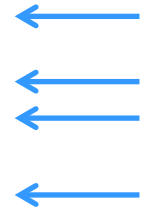
Cable and air hose routing under the shroud



# SSD Upcoming Reviews



WBS	New Task Name	New Date	Old Date
1.4.2.1.1.2	L2 CP - SSD Prototype Ladder Board Design Finished	10/15/2010	10/15/2010
1.4.2.2.1.3	L2 CP - SSD QRDO Board design finished	7/19/2011	7/25/2011
1.4.2.2.1.7	L3 CP - QRDO Complete	8/23/2011	5/9/2011
1.4.2.1.1.9	L3 CP - Ladder Board Prototype Phase I Complete	10/31/2011	7/6/2011
1.4.4.1.1.2	L3 CP - PCB for Ladder Board Cable Ready for Fabrication	11/2/2011	9/2/2011
1.4.2.3.2.2	L3 CP - Production DAQ Design Review Completed	11/28/2011	11/28/2011
1.4.2.2.1.15	L3 CP - SSD RDO Design Finished	1/27/2012	
1.4.1.2	L3 CP - Mechanical Design of SSD components on OSC complete - HFT design Review to sign off	6/1/2012	6/1/2012
1.4.4.2.9	L3 CP - Power Supply Design Review Complete	6/29/2012	2/8/2012
1.4.2.2.2.4	L2 CP - SSD Preproduction Design Review of RDO	7/13/2012	5/30/2012
1.4.2.1.2.10	L3 CP - Preproduction Ladder Board PCB Received	8/10/2012	8/31/2012
1.4.2.1.3.2	L3 CP - Production Ladder Board Internal Review Completed	10/8/2012	10/29/2012
1.4.2.1.3.4	L2 CP - SSD Production of Ladder Boards Ready to Begin	11/6/2012	11/29/2012
1.4.2.1.3.7	L3 CP - Production Ladder Board PCB Received	1/22/2013	2/12/2013
1.4.4.4.2.12	L3 CP - Slow controls ready for testing	1/30/2013	4/18/2012
1.4.2.2.3.7	L3 CP - Production RDO Board Received	3/22/2013	2/6/2013
1.4.1.7	L3 CP - Mechanical Components on OSC Installed	4/1/2013	4/1/2013
1.4.2.5	L3 CP - Electronics Complete	6/14/2013	7/22/2013
1.4.3.1.5	L3 CP - Survey Complete	7/9/2013	5/30/2013
1.4.4.3.15	L3 CP - Installation of cooling on STAR platform and Magnet Endcap complete	8/16/2013	7/31/2013
1.4.3.2.7	L2 CP - SSD Assembled on OSC Ready for Installation	8/28/2013	7/1/2013



Complete
Future
Late

Also a safety review, soon, with Yousef Makdisi et al.

# Summary

---



- Excellent progress on many conventional systems
- Nothing particularly unusual or complex
- Much work remains to be done